



February 2008



# 74VHC164

## 8-Bit Serial-In, Parallel-Out Shift Register

### Features

- High Speed:  $f_{MAX} = 175\text{MHz}$  at  $V_{CC} = 5\text{V}$
- Low power dissipation:  $I_{CC} = 4\mu\text{A}$  (max.) at  $T_A = 25^\circ\text{C}$
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC}$  (min.)
- Power down protection provided on all inputs
- Low noise:  $V_{OLP} = 0.8\text{V}$  (max.)
- Pin and function compatible with 74HC164

### General Description

The VHC164 is an advanced high-speed CMOS device fabricated with silicon gate CMOS technology. It achieves the high-speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation. The VHC164 is a high-speed 8-Bit Serial-In/Parallel-Out Shift Register. Serial data is entered through a 2-input AND gate synchronous with the LOW-to-HIGH transition of the clock. The device features an asynchronous Master Reset which clears the register, setting all outputs LOW independent of the clock. An input protection circuit insures that 0V to 7V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5V to 3V systems and two supply systems such as battery backup. This circuit prevents device destruction due to mismatched supply and input voltages.

---

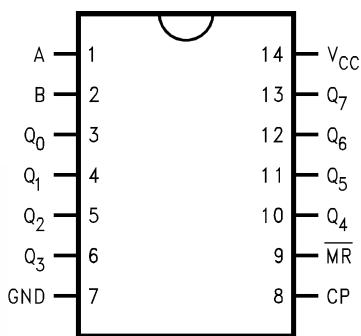
### Ordering Information

Order Number	Package Number	Package Description
74VHC164M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74VHC164SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74VHC164MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74VHC164N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

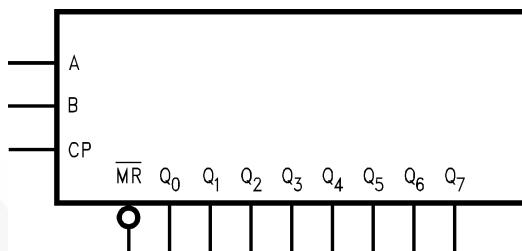
Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

All packages are lead free per JEDEC: J-STD-020B standard.

### Connection Diagram



### Logic Symbol



### Pin Description

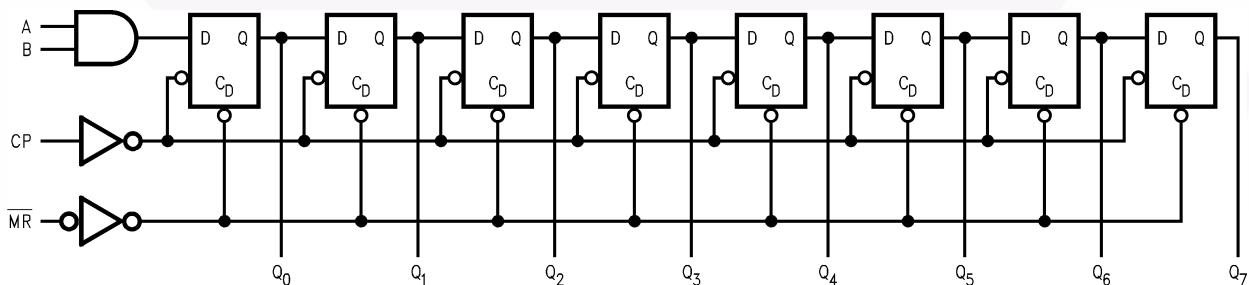
Pin Names	Description
A, B	Data Inputs
CP	Clock Pulse Input (Active Rising Edge)
MR-bar	Master Reset Input (Active LOW)
Q0-Q7	Outputs

### Functional Description

The VHC164 is an edge-triggered 8-bit shift register with serial data entry and an output from each of the eight stages. Data is entered serially through one of two inputs (A or B); either of these inputs can be used as an active High Enable for data entry through the other input. An unused input must be tied HIGH.

Each LOW-to-HIGH transition on the Clock (CP) input shifts data one place to the right and enters into Q<sub>0</sub> the logical AND of the two data inputs (A • B) that existed before the rising clock edge. A LOW level on the Master Reset (MR) input overrides all other inputs and clears the register asynchronously, forcing all Q outputs LOW.

### Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
$V_{CC}$	Supply Voltage	-0.5V to +7.0V
$V_{IN}$	DC Input Voltage	-0.5V to +7.0V
$V_{OUT}$	DC Output Voltage	-0.5V to $V_{CC}$ + 0.5V
$I_{IK}$	Input Diode Current	-20mA
$I_{OK}$	Output Diode Current	$\pm$ 20mA
$I_{OUT}$	DC Output Current	$\pm$ 25mA
$I_{CC}$	DC $V_{CC}$ /GND Current	$\pm$ 75mA
$T_{STG}$	Storage Temperature	-65°C to +150°C
$T_L$	Lead Temperature (Soldering, 10 seconds)	260°C

## Recommended Operating Conditions<sup>(1)</sup>

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating
$V_{CC}$	Supply Voltage	2.0V to 5.5V
$V_{IN}$	Input Voltage	0V to +5.5V
$V_{OUT}$	Output Voltage	0V to $V_{CC}$
$T_{OPR}$	Operating Temperature	-40°C to +85°C
$t_r, t_f$	Input Rise and Fall Time, $V_{CC} = 3.3V \pm 0.3V$ $V_{CC} = 5.0V \pm 0.5V$	0ns/V ~ 100ns/V 0ns/V ~ 20ns/V

### Note:

- Unused inputs must be held HIGH or LOW. They may not float.

## DC Electrical Characteristics

Symbol	Parameter	$V_{CC}$ (V)	Conditions	$T_A = 25^\circ C$			$T_A = -40^\circ C$ to $+85^\circ C$		Units
				Min.	Typ.	Max.	Min.	Max.	
$V_{IH}$	HIGH Level Input Voltage	2.0		1.50			1.50		V
		3.0–5.5		0.7 $\times V_{CC}$			0.7 $\times V_{CC}$		
$V_{IL}$	LOW Level Input Voltage	2.0				0.50		0.50	V
		3.0–5.5				0.3 $\times V_{CC}$		0.3 $\times V_{CC}$	
$V_{OH}$	HIGH Level Output Voltage	2.0	$V_{IN} = V_{IH}$ or $V_{IL}$	$I_{OH} = -50\mu A$	1.9	2.0		1.9	V
		3.0			2.9	3.0		2.9	
		4.5			4.4	4.5		4.4	
		3.0		$I_{OH} = -4mA$	2.58			2.48	
		4.5		$I_{OH} = -8mA$	3.94			3.80	
$V_{OL}$	LOW Level Output Voltage	2.0	$V_{IN} = V_{IH}$ or $V_{IL}$	$I_{OL} = 50\mu A$		0.0	0.1		V
		3.0				0.0	0.1		
		4.5				0.0	0.1		
		3.0		$I_{OL} = 4mA$			0.36		
		4.5		$I_{OL} = 8mA$			0.36		
$I_{IN}$	Input Leakage Current	0–5.5	$V_{IN} = 5.5V$ or GND				$\pm 0.1$		$\mu A$
$I_{CC}$	Quiescent Supply Current	5.5	$V_{IN} = V_{CC}$ or GND				4.0		$\mu A$

## Noise Characteristics

Symbol	Parameter	$V_{CC}$ (V)	Conditions	$T_A = 25^\circ C$		Units
				Typ.	Limits	
$V_{OLP}^{(2)}$	Quiet Output Maximum Dynamic $V_{OL}$	5.0	$C_L = 50pF$	0.5	0.8	V
$V_{OLV}^{(2)}$	Quiet Output Minimum Dynamic $V_{OL}$	5.0	$C_L = 50pF$	-0.5	-0.8	V
$V_{IHD}^{(2)}$	Minimum HIGH Level Dynamic Input Voltage	5.0	$C_L = 50pF$		3.5	V
$V_{ILD}^{(2)}$	Maximum LOW Level Dynamic Input Voltage	5.0	$C_L = 50pF$		1.5	V

**Note:**

2. Parameter guaranteed by design.

## AC Electrical Characteristics

Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	T <sub>A</sub> = 25°C			T <sub>A</sub> = -40°C to +85°C		Units
				Min.	Typ.	Max.	Min.	Max.	
f <sub>MAX</sub>	Maximum Clock Frequency	3.3 ± 0.3	C <sub>L</sub> = 15pF, R <sub>L</sub> = 1kΩ	80	125		65		MHz
			C <sub>L</sub> = 50pF, R <sub>L</sub> = 1kΩ	50	75		45		
		5.0 ± 0.5	C <sub>L</sub> = 15pF, R <sub>L</sub> = 1kΩ	125	175		105		
			C <sub>L</sub> = 50pF, R <sub>L</sub> = 1kΩ	85	115		75		
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay Time (CP–Q <sub>n</sub> )	3.3 ± 0.3	C <sub>L</sub> = 15pF, R <sub>L</sub> = 1kΩ		8.4	12.8	1.0	15.0	ns
			C <sub>L</sub> = 50pF, R <sub>L</sub> = 1kΩ		10.9	16.3	1.0	18.5	
		5.0 ± 0.5	C <sub>L</sub> = 15pF, R <sub>L</sub> = 1kΩ		5.8	9.0	1.0	10.5	
			C <sub>L</sub> = 50pF, R <sub>L</sub> = 1kΩ		7.3	11.0	1.0	12.5	
t <sub>PHL</sub>	Propagation Delay Time (MR–Q <sub>n</sub> )	3.3 ± 0.3	C <sub>L</sub> = 15pF, R <sub>L</sub> = 1kΩ		8.3	12.8	1.0	15.0	ns
			C <sub>L</sub> = 50pF, R <sub>L</sub> = 1kΩ		10.8	16.3	1.0	18.5	
		5.0 ± 0.5	C <sub>L</sub> = 15pF, R <sub>L</sub> = 1kΩ		5.2	8.6	1.0	10.0	
			C <sub>L</sub> = 50pF, R <sub>L</sub> = 1kΩ		6.7	10.6	1.0	12.0	
C <sub>IN</sub>	Input Capacitance		V <sub>CC</sub> = Open		4	10		10	pF
C <sub>PD</sub>	Power Dissipation Capacitance		(3)		76				pF

**Note:**

3. C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained from the equation:

$$I_{CC} (\text{opr.}) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$$

## AC Operating Requirements

Symbol	Parameter	V <sub>CC</sub> (V) <sup>(4)</sup>	T <sub>A</sub> = 25°C		T <sub>A</sub> = -40°C to +85°C		Units
			Typ.	Guaranteed Minimum			
t <sub>W(L)</sub> , t <sub>W(H)</sub>	Minimum Pulse Width (CP)	3.3		5.0	5.0		ns
		5.0		5.0	5.0		
t <sub>W(L)</sub>	Minimum Pulse Width (MR)	3.3		5.0	5.0		ns
		5.0		5.0	5.0		
t <sub>S</sub>	Minimum Setup Time	3.3		5.0	6.0		ns
		5.0		4.5	4.5		
t <sub>H</sub>	Minimum Hold Time	3.3		0.0	0.0		ns
		5.0		1.0	1.0		
t <sub>REC</sub>	Minimum Removal Time (MR)	3.3		2.5	2.5		ns
		5.0		2.5	2.5		

**Note:**

4. V<sub>CC</sub> is 3.3 ± 0.3V or 5.0 ± 0.5V

## Physical Dimensions

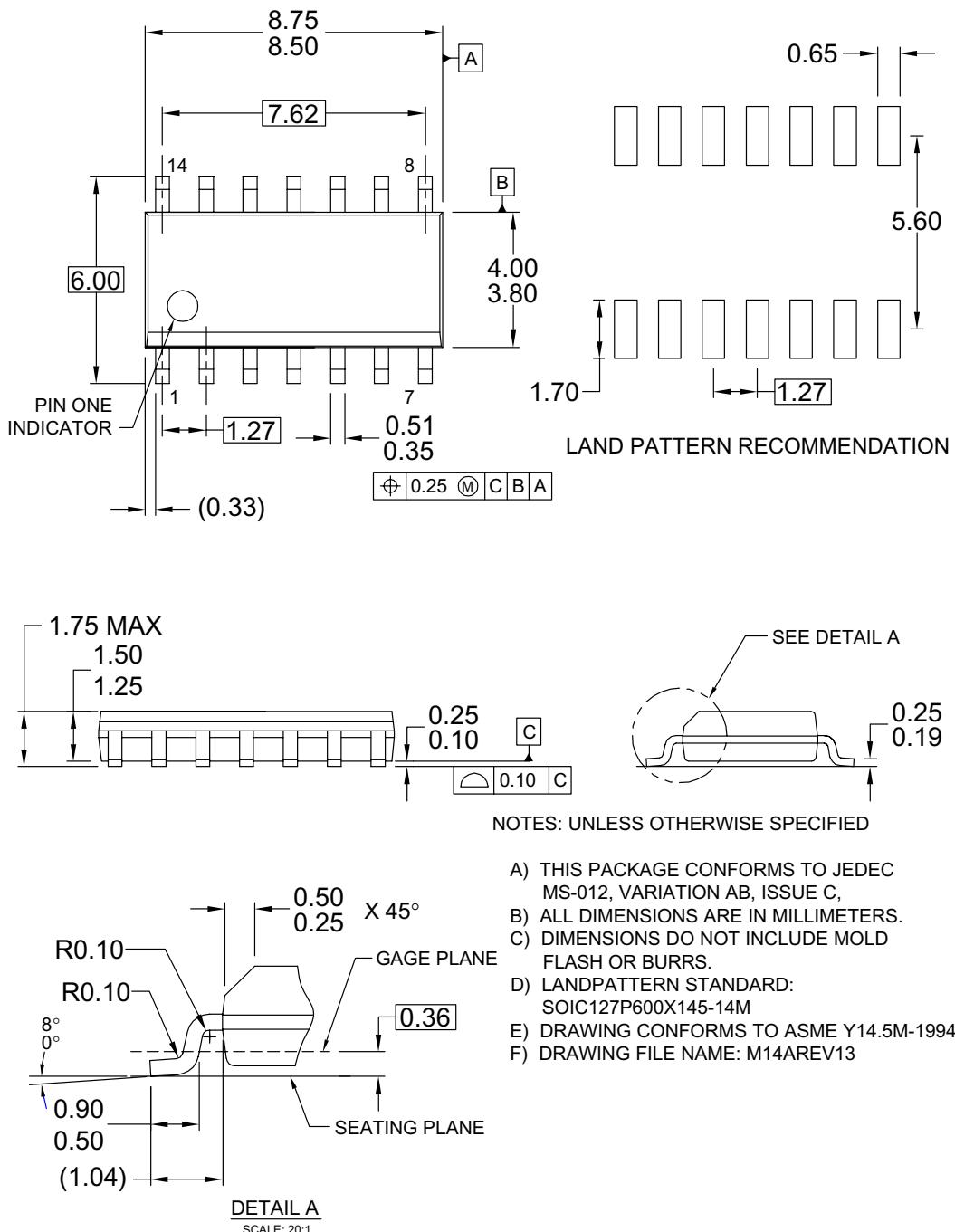


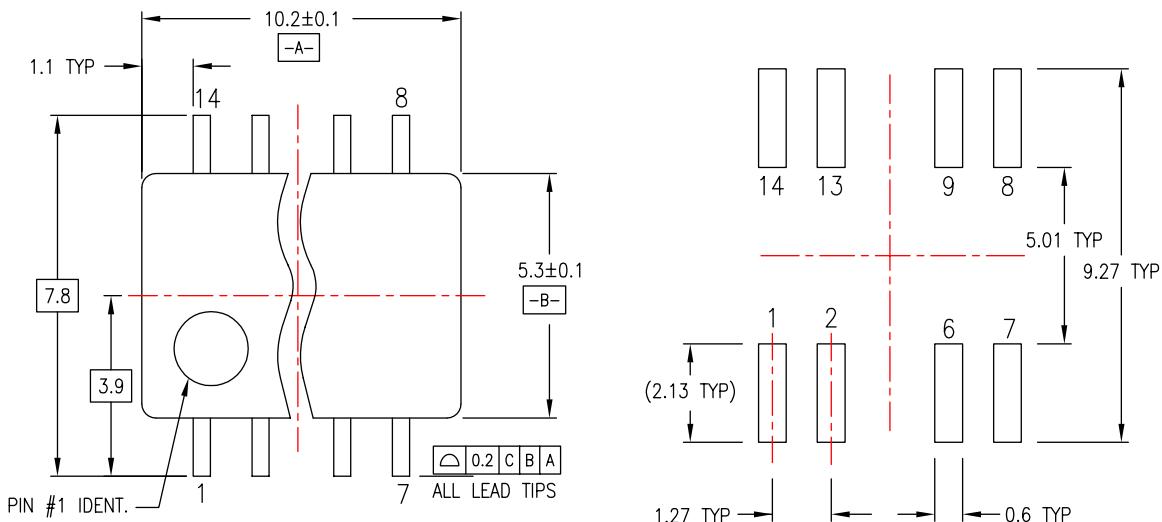
Figure 1. 14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

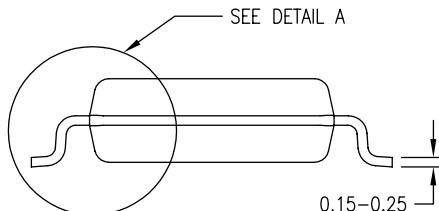
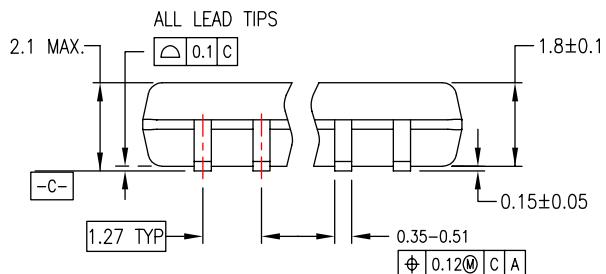
Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

<http://www.fairchildsemi.com/packaging/>

## Physical Dimensions (Continued)



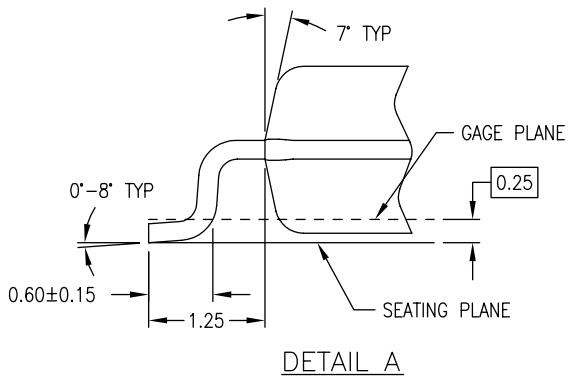
### LAND PATTERN RECOMMENDATION



DIMENSIONS ARE IN MILLIMETERS

### NOTES:

- A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.



DETAIL A

M14DREVC

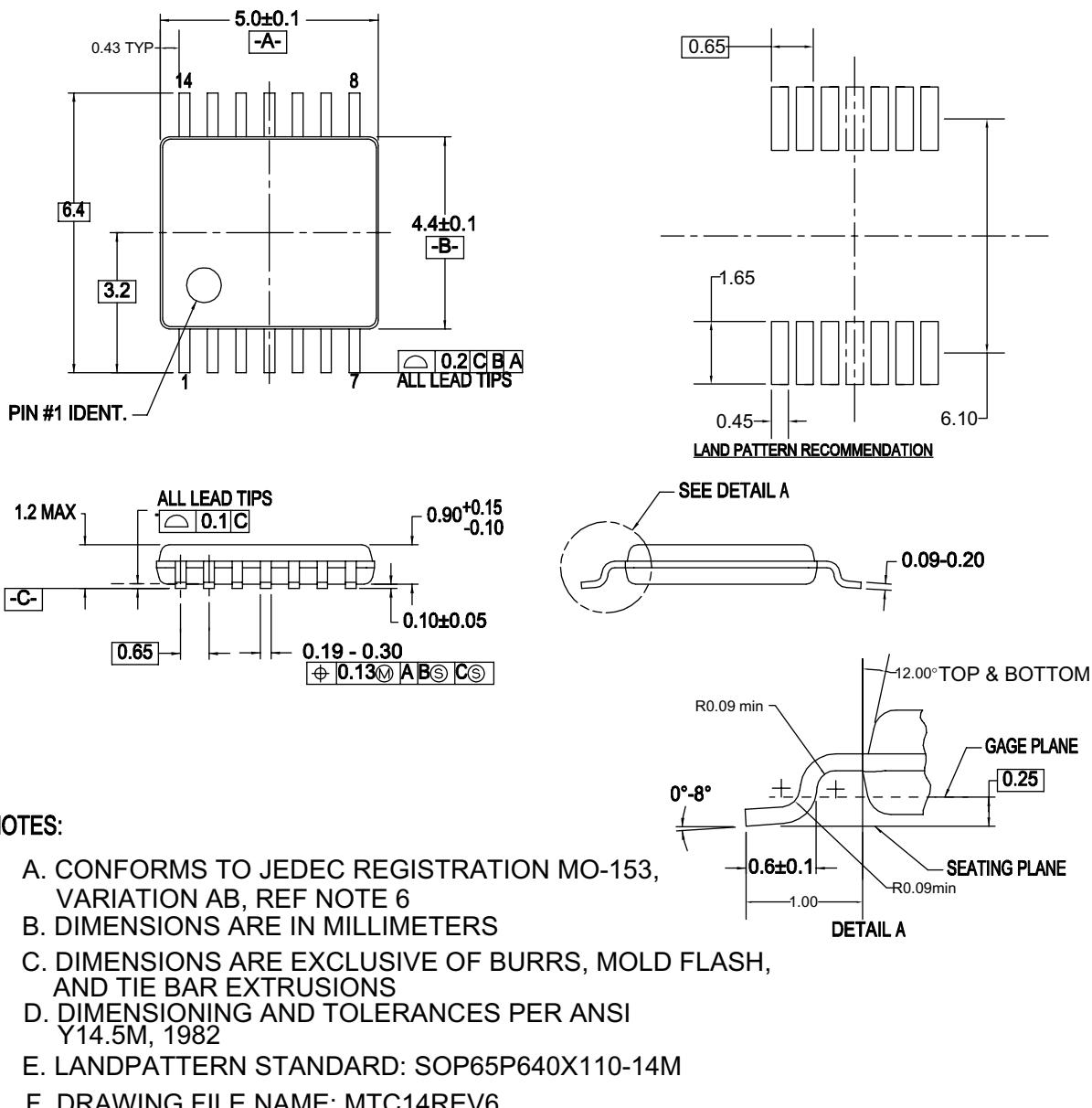
**Figure 2. 14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide**

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

<http://www.fairchildsemi.com/packaging/>

## Physical Dimensions (Continued)



### NOTES:

- CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB, REF NOTE 6
- DIMENSIONS ARE IN MILLIMETERS
- DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
- DIMENSIONING AND TOLERANCES PER ANSI Y14.5M, 1982
- LANDPATTERN STANDARD: SOP65P640X110-14M
- DRAWING FILE NAME: MTC14REV6

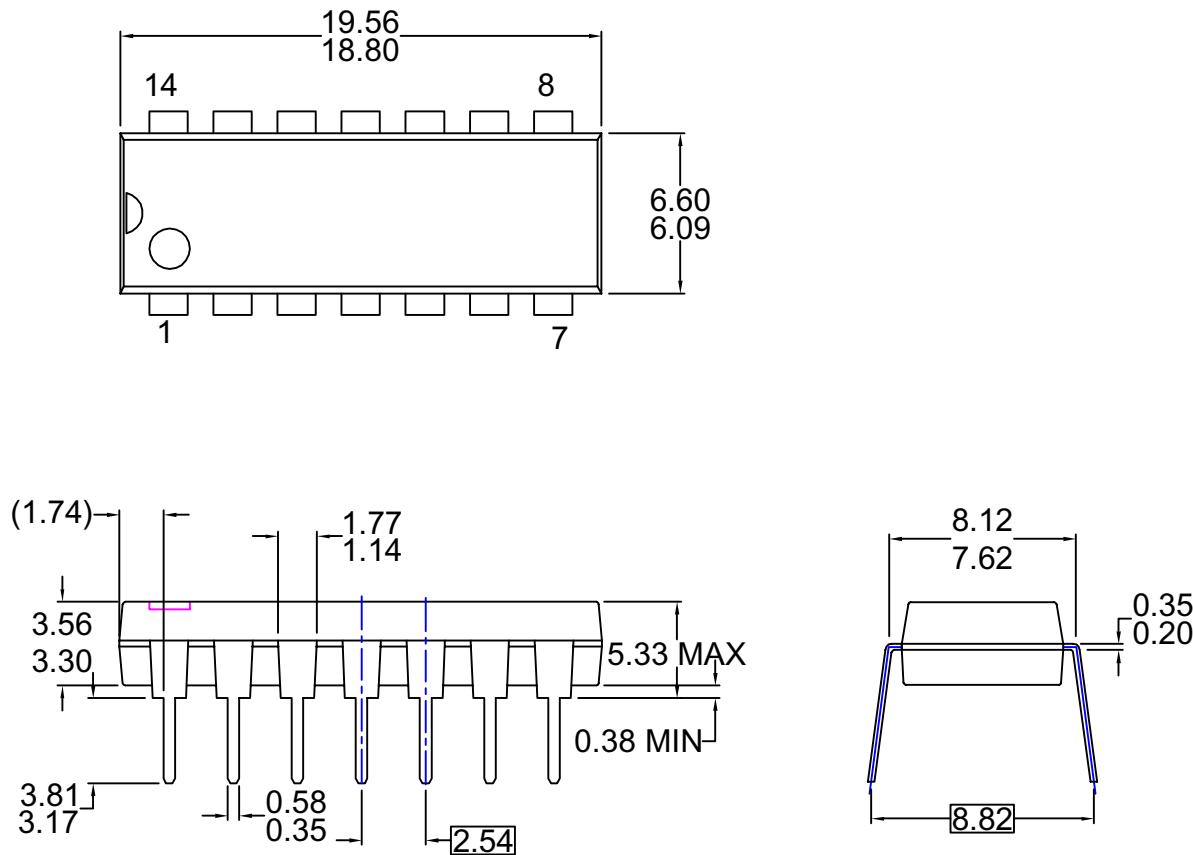
Figure 3. 14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

<http://www.fairchildsemi.com/packaging/>

### Physical Dimensions (Continued)



**NOTES: UNLESS OTHERWISE SPECIFIED**  
**THIS PACKAGE CONFORMS TO**  
**A) JEDEC MS-001 VARIATION BA**  
**B) ALL DIMENSIONS ARE IN MILLIMETERS.**  
**C) DIMENSIONS ARE EXCLUSIVE OF BURRS,**  
**D) MOLD FLASH, AND TIE BAR EXTRUSIONS.**  
**E) DIMENSIONS AND TOLERANCES PER**  
**ASME Y14.5-1994**  
**F) DRAWING FILE NAME: MKT-N14AREV7**

**Figure 4. 14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide**

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

<http://www.fairchildsemi.com/packaging/>



## TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

ACEx®	FPS™	PDP-SPM™	SyncFET™
Build it Now™	FRFET®	Power220®	SYSTEM ®
CorePLUS™	Global Power Resource™	Power247®	GENERAL
CROSSVOLT™	Green FPS™	POWEREDGE®	The Power Franchise®
CTL™	Green FPS™ e-Series™	Power-SPM™	the power franchise
Current Transfer Logic™	GTO™	PowerTrench®	TinyBoost™
EcoSPARK®	i-Lo™	Programmable Active Droop™	TinyBuck™
EZSWITCH™ *	IntelliMAX™	QFET®	TinyLogic®
F™	ISOPLANAR™	QS™	TINYOPTO™
Fairchild®	MegaBuck™	QT Optoelectronics™	TinyPower™
Fairchild Semiconductor®	MICROCOUPLER™	Quiet Series™	TinyPWM™
FACT Quiet Series™	MicroFET™	RapidConfigure™	TinyWire™
FACT®	MicroPak™	SMART START™	µSerDes™
FAST®	MillerDrive™	SPM®	UHC®
FastvCore™	Motion-SPM™	STEALTH™	Ultra FRFET™
FlashWriter® *	OPTOLOGIC®	SuperFET™	UniFET™
	OPTOPLANAR®	SuperSOT™-3	VCX™
		SuperSOT™-6	
		SuperSOT™-8	

\* EZSWITCH™ and FlashWriter® are trademarks of System General Corporation, used under license by Fairchild Semiconductor.

## DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

## LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

## PRODUCT STATUS DEFINITIONS

### Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild Semiconductor. The datasheet is printed for reference information only.

Rev. I32



**Стандарт  
Электрон  
Связь**

Мы молодая и активно развивающаяся компания в области поставок электронных компонентов. Мы поставляем электронные компоненты отечественного и импортного производства напрямую от производителей и с крупнейших складов мира.

Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

Мы осуществляем техническую поддержку нашим клиентам и предпродажную проверку качества продукции. На все поставляемые продукты мы предоставляем гарантию .

Осуществляем поставки продукции под контролем ВП МО РФ на предприятия военно-промышленного комплекса России , а также работаем в рамках 275 ФЗ с открытием отдельных счетов в уполномоченном банке. Система менеджмента качества компании соответствует требованиям ГОСТ ISO 9001.

Минимальные сроки поставки, гибкие цены, неограниченный ассортимент и индивидуальный подход к клиентам являются основой для выстраивания долгосрочного и эффективного сотрудничества с предприятиями радиоэлектронной промышленности, предприятиями ВПК и научно-исследовательскими институтами России.

С нами вы становитесь еще успешнее!

**Наши контакты:**

**Телефон:** +7 812 627 14 35

**Электронная почта:** [sales@st-electron.ru](mailto:sales@st-electron.ru)

**Адрес:** 198099, Санкт-Петербург,  
Промышленная ул, дом № 19, литер Н,  
помещение 100-Н Офис 331